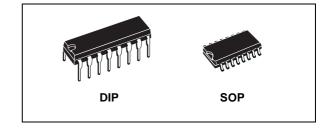




HEX BUFFER/CONVERTER (NON INVERTING)

- PROPAGATION DELAY TIME : t_{PD} = 40ns (TYP.) at V_{DD} = 10V C_L = 50pF
- HIGH TO LOW LEVEL LOGIC CONVERSION
- HIGH "SINK" AND "SOURCE" CURRENT CAPABILITY
- QUIESCENT CURRENT SPECIFIED UP TO 20V
- 5V, 10V AND 15V PARAMETRIC RATINGS
- INPUT LEAKAGE CURRENT I_I = 100nA (MAX) AT V_{DD} = 18V T_A = 25°C
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC JESD13B " STANDARD SPECIFICATIONS FOR DESCRIPTION OF B SERIES CMOS DEVICES"



ORDER CODES

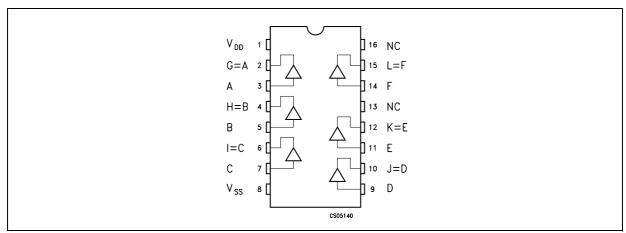
PACKAGE	TUBE	T&R
DIP	HCF4050BEY	
SOP	HCF4050BM1	HCF4050M013TR

DESCRIPTION

The HCF4050B is a monolithic integrated circuit fabricated in Metal Oxide Semiconductor technology available in DIP and SOP packages. It is an non inverting Hex Buffer/Converter and feature logic level conversions using only one supply voltage (V_{DD}).

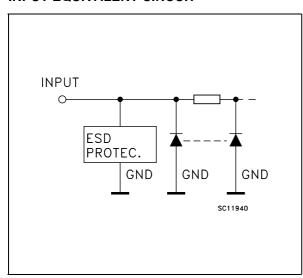
The input high level signal (V_{IH}) can exceed the V_{DD} supply voltage when these devices are used for logic level conversions. This device is intended for use as CMOS to DTL/TTL converters and can drive directly two DTL/TTL loads (V_{DD}=5V, V_{OL}≤0.4V and I_{OL}≤3.2mA.

PIN CONNECTION



May 2003 1/9

INPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

PIN No	SYMBOL	NAME AND FUNCTION
3, 5, 7, 9, 11, 14	A, B, C, D, E, F	Data Inputs
2, 4, 6, 10, 12, 15	G, H, I, J, K, L	Data Outputs
13 , 16	NC	Not Connected
8	V _{SS}	Negative Supply Voltage
1	V_{DD}	Positive Supply Voltage

TRUTH TABLE

INPUTS	OUTPUTS
A, B, C, D,E, F	G, H, I, J, K, L
L	L
Н	Н

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{DD}	Supply Voltage	-0.5 to +22	V
V _I	DC Input Voltage	-0.5 to +18	V
l _l	DC Input Current	± 10	mA
P _D	Power Dissipation per Package	200	mW
	Power Dissipation per Output Transistor	100	mW
T _{op}	Operating Temperature	-55 to +125	°C
T _{stg}	Storage Temperature	-65 to +150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

All voltage values are referred to V_{SS} pin voltage.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V _{DD}	Supply Voltage	3 to 20	V
V _I	Input Voltage	-0.5 to 15V	V
T _{op}	Operating Temperature	-55 to 125	°C

DC SPECIFICATIONS

		Test Condition				Value							
Symbol	Parameter	VI	v _o	l _o	V_{DD}	T _A = 25°C			-40 to 85°C		-55 to 125°C		Unit
		(V)	(V)	(μ A)	(V)	Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
ΙL	Quiescent Current	0/5			5		0.02	1		30		30	
		0/10			10		0.02	2		60		60	^
		0/15			15		0.02	4		120		120	μΑ
		0/20			20		0.04	20		600		600	
V _{OH}	High Level Output	0/5		<1	5	4.95			4.95		4.95		
	Voltage	0/10		<1	10	9.95			9.95		9.95		V
		0/15		<1	15	14.95			14.95		14.95		
V _{OL}	Low Level Output	5/0		<1	5		0.05			0.05		0.05	
	Voltage	10/0		<1	10		0.05			0.05		0.05	V
		15/0		<1	15		0.05			0.05		0.05	
V _{IH}	High Level Input		0.5/4.5	<1	5	3.5			3.5		3.5		
	Voltage		1/9	<1	10	7			7		7		V
			1.5/13.5	<1	15	11			11		11		
V _{IL}	Low Level Input		4.5/0.5	<1	5			1.5		1.5		1.5	
	Voltage		9/1	<1	10			3		3		3	V
			13.5/1.5	<1	15			4		4		4	
I _{OH}	Output Drive	0/5	2.5	<1	5	-1.25	-6.4		-0.42		-0.42		
	Current	0/5	4.6	<1	5	-0.51	-1.6		-0.38		-0.38		mA
		0/10	9.5	<1	10	-1.25	-3.6		-1		-1		IIIA
		0/15	13.5	<1	15	-3.75	-12		-3		-3		
I _{OL}	Output Sink	0/5	0.4	<1	5	3.2	6.4		2.6		2.6		
	Current	0/10	0.5	<1	10	8	16		6.6		6.6		mΑ
		0/15	1.5	<1	15	24	48		19		19		
I _I	Input Leakage Current	0/18	Any In	put	18		±10 ⁻⁵	±0.1		±1		±1	μΑ
Cı	Input Capacitance		Any In	put		_	5	7.5					pF

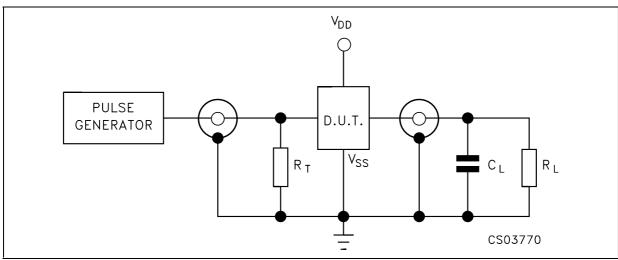
The Noise Margin for both "1" and "0" level is: 1V min. with V_{DD} =5V, 2V min. with V_{DD} =10V, 2.5V min. with V_{DD} =15V

$\textbf{DYNAMIC ELECTRICAL CHARACTERISTICS} \; (T_{amb} = 25 ^{\circ}\text{C}, \;\; C_{L} = 50 \text{pF}, \; R_{L} = 200 \text{K}\Omega, \;\; t_{f} = t_{f} = 20 \; \text{ns})$

	_		Test Condition			Value (*)		
Symbol	Parameter	V _{DD} (V)	V _I (V)		Min.	Тур.	Max.	
t _{TLH}	Output Transition Time	5	5			80	160	
		10	10			40	80	ns
		15	15			30	60	
t _{THL}	Output Transition Time	5	5			30	60	
		10	10			20	40	ns
		15	15			15	30	
t _{PLH}	Propagation Delay Time	5	5			70	140	
		10	10			40	80	
		5	10			45	90	ns
		15	15			30	60	
		5	15			40	80	
t _{PHL}	Propagation Delay Time	5	5			55	110	
		10	10			22	55	
		5	10			50	100	ns
		15	15			15	30	
		5	15			50	100	

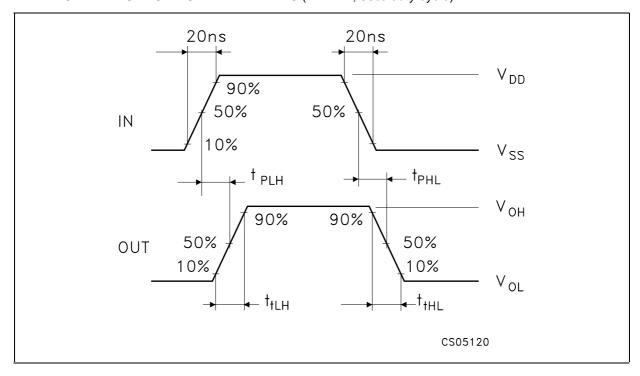
^(*) Typical temperature coefficient for all V_{DD} value is 0.3 %/°C.

TEST CIRCUIT



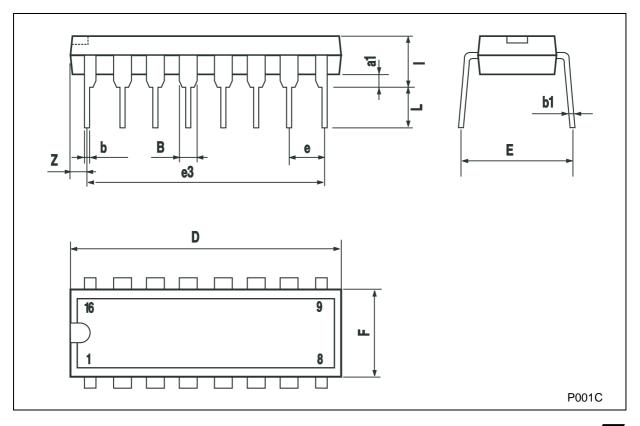
 C_L = 50pF or equivalent (includes jig and probe capacitance) R_L = 200K Ω R_T = Z_{OUT} of pulse generator (typically 50 Ω)

WAVEFORM: PROPAGATION DELAY TIMES (f=1MHz; 50% duty cycle)



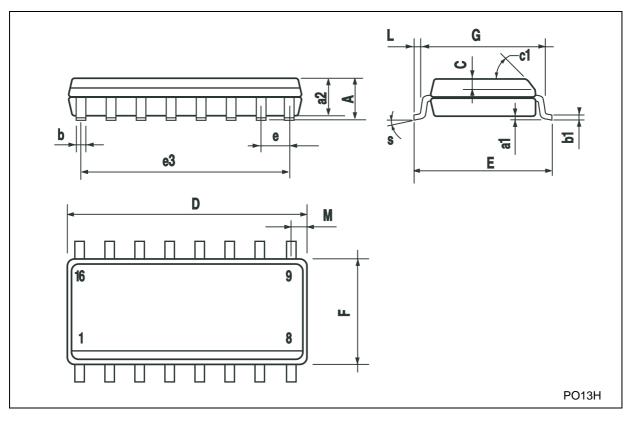
Plastic DIP-16 (0.25) MECHANICAL DATA

DIM		mm.		inch				
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.		
a1	0.51			0.020				
В	0.77		1.65	0.030		0.065		
b		0.5			0.020			
b1		0.25			0.010			
D			20			0.787		
Е		8.5			0.335			
е		2.54			0.100			
e3		17.78			0.700			
F			7.1			0.280		
I			5.1			0.201		
L		3.3			0.130			
Z			1.27			0.050		



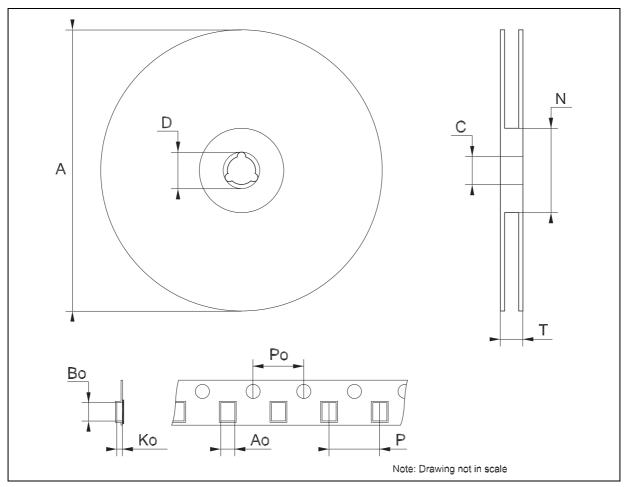
SO-16 MECHANICAL DATA

DIM		mm.		inch			
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
А			1.75			0.068	
a1	0.1		0.2	0.004		0.008	
a2			1.65			0.064	
b	0.35		0.46	0.013		0.018	
b1	0.19		0.25	0.007		0.010	
С		0.5			0.019		
c1			45°	(typ.)			
D	9.8		10	0.385		0.393	
Е	5.8		6.2	0.228		0.244	
е		1.27			0.050		
e3		8.89			0.350		
F	3.8		4.0	0.149		0.157	
G	4.6		5.3	0.181		0.208	
L	0.5		1.27	0.019		0.050	
М			0.62			0.024	
S	8		° (r	max.)	1	1	



Tape & Reel SO-16 MECHANICAL DATA

DIM		mm.		inch			
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
А			330			12.992	
С	12.8		13.2	0.504		0.519	
D	20.2			0.795			
N	60			2.362			
Т			22.4			0.882	
Ao	6.45		6.65	0.254		0.262	
Во	10.3		10.5	0.406		0.414	
Ko	2.1		2.3	0.082		0.090	
Po	3.9		4.1	0.153		0.161	
Р	7.9		8.1	0.311		0.319	



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